

THE LEGEND OF THE ATLAS EXPERIMENT

ATLAS ITK STRIP DETECTOR

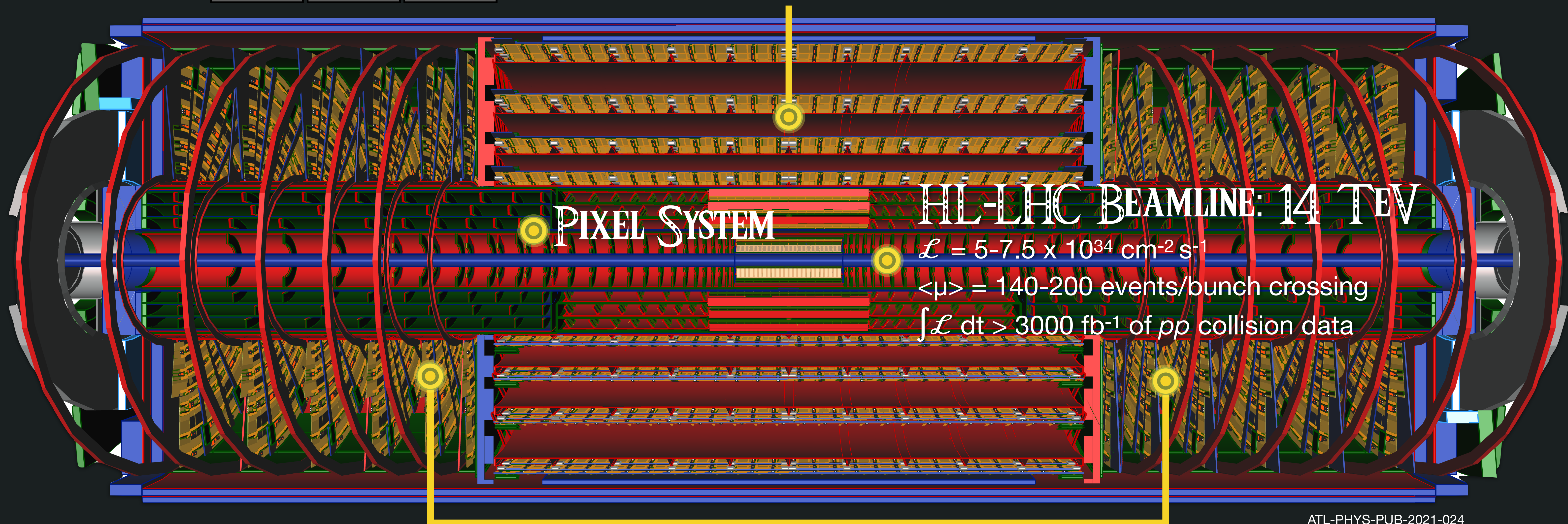
FOR THE PHASE-II UPGRADE

Hannah Herde (Lund University) on behalf of the ATLAS-ITk Collaboration



INNER TRACKER (ITK) STRIP BARREL

Integrated at CERN



ATL-PHYS-PUB-2021-024

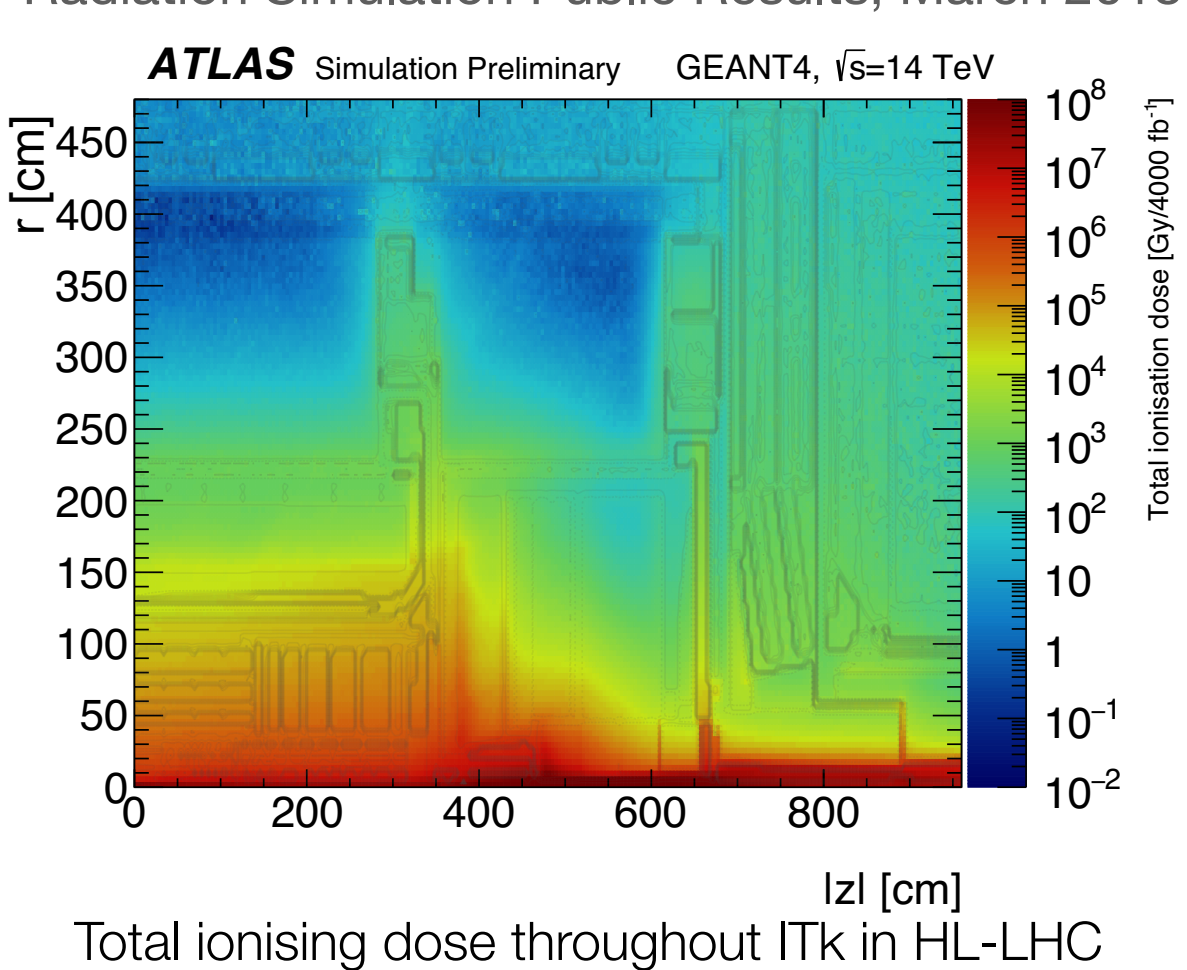


STRIP ENDCAPS

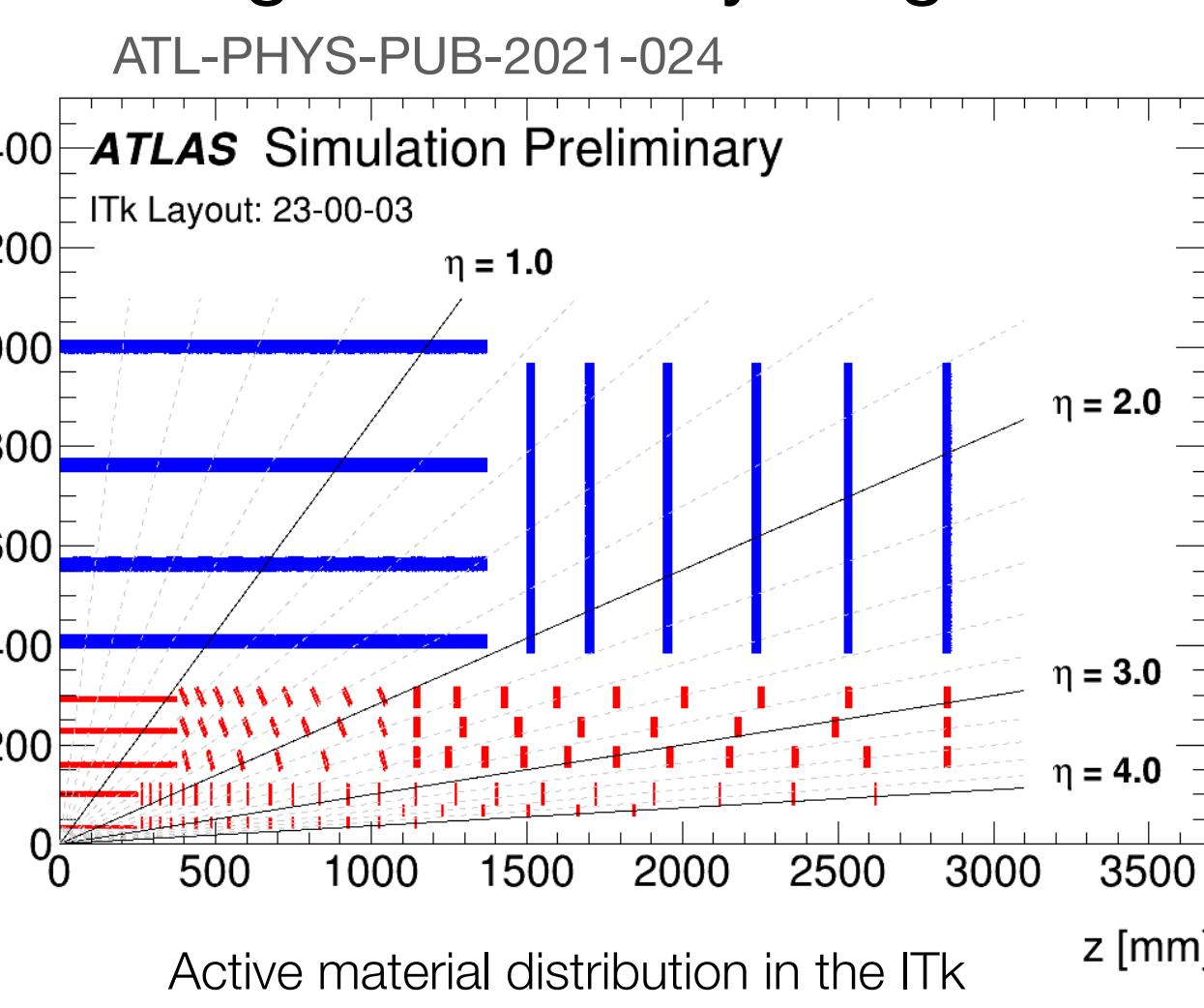
Integrated at DESY and NIKHEF

ATLAS Inner Tracker: Full silicon detector solution replacing current Pixel, Semiconductor Tracker (SCT), and Transition Radiation Tracker (TRT) sub-detectors for High Luminosity Large Hadron Collider (HL-LHC) with similar or better performance in harsher conditions

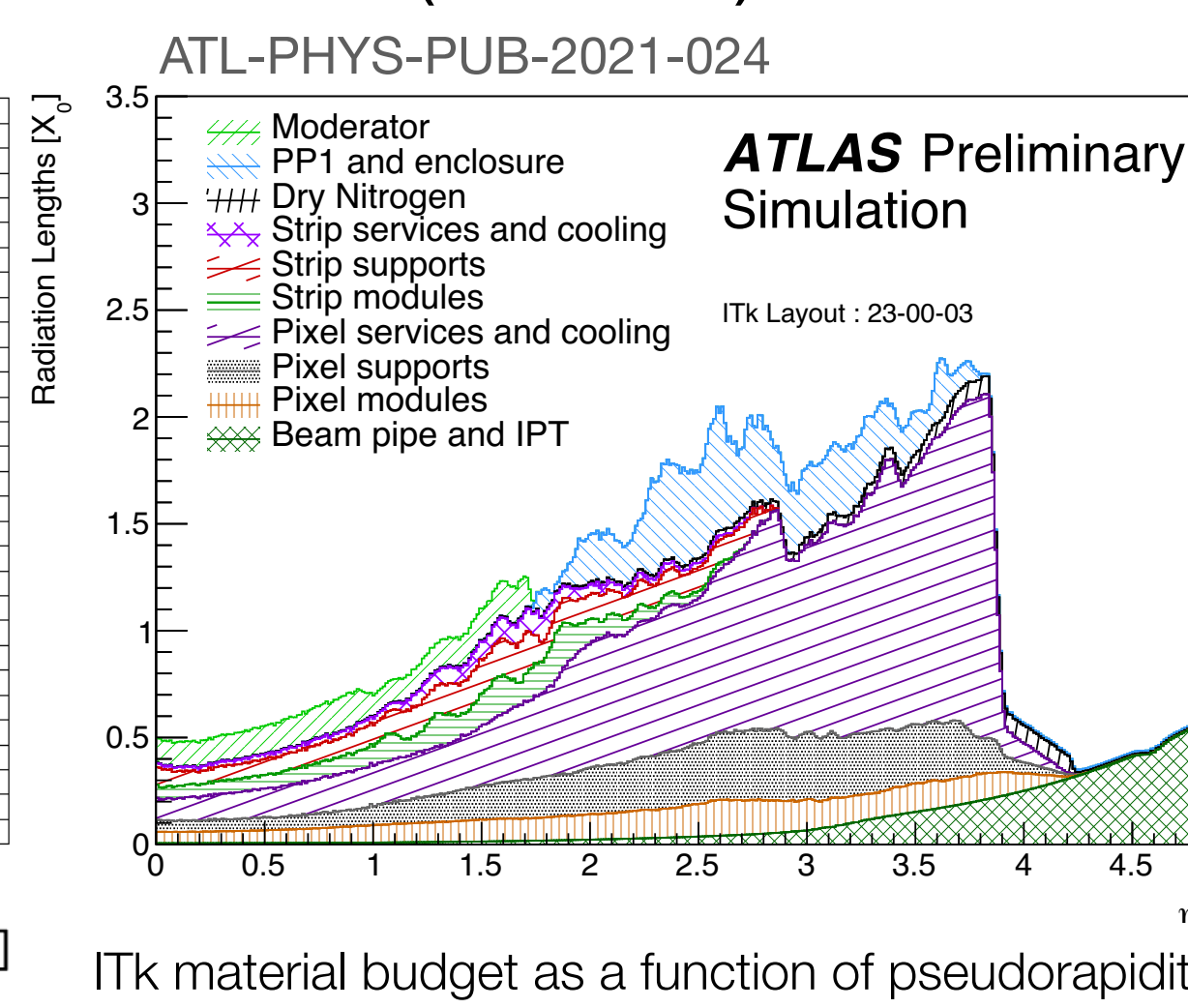
Radiation Simulation Public Results, March 2018



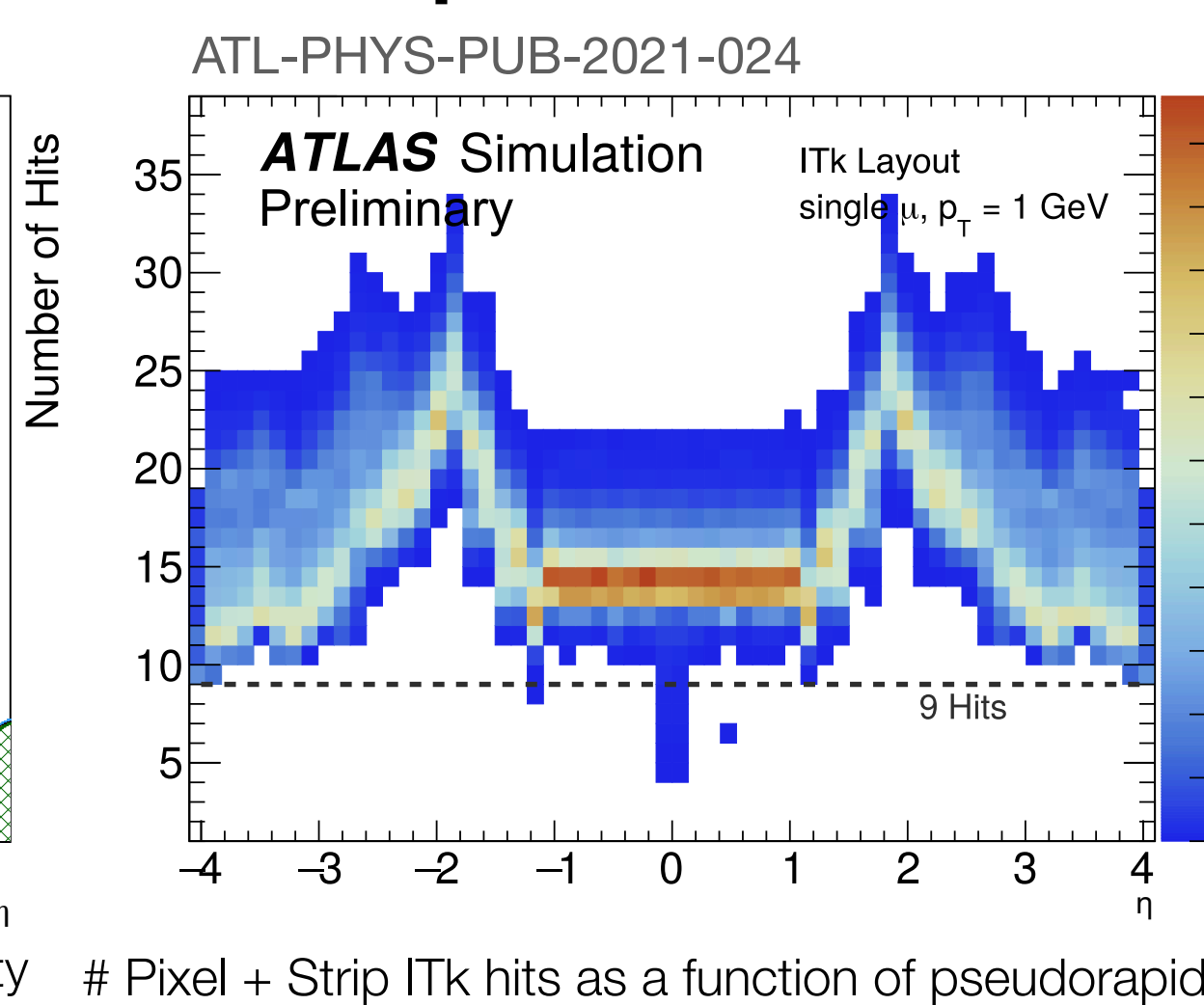
Total ionising dose throughout ITk in HL-LHC



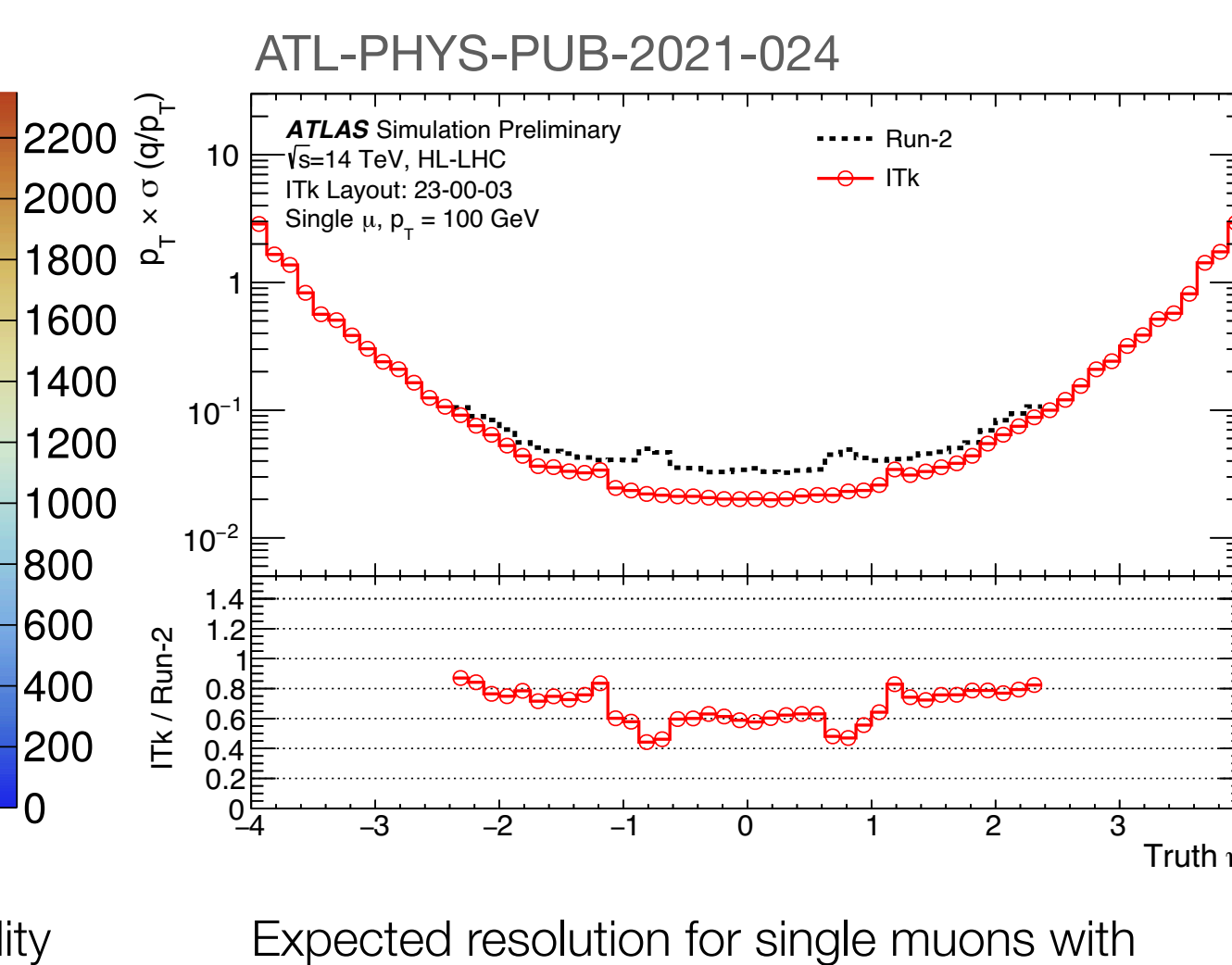
Active material distribution in the ITk



ITk material budget as a function of pseudorapidity



Pixel + Strip ITk hits as a function of pseudorapidity



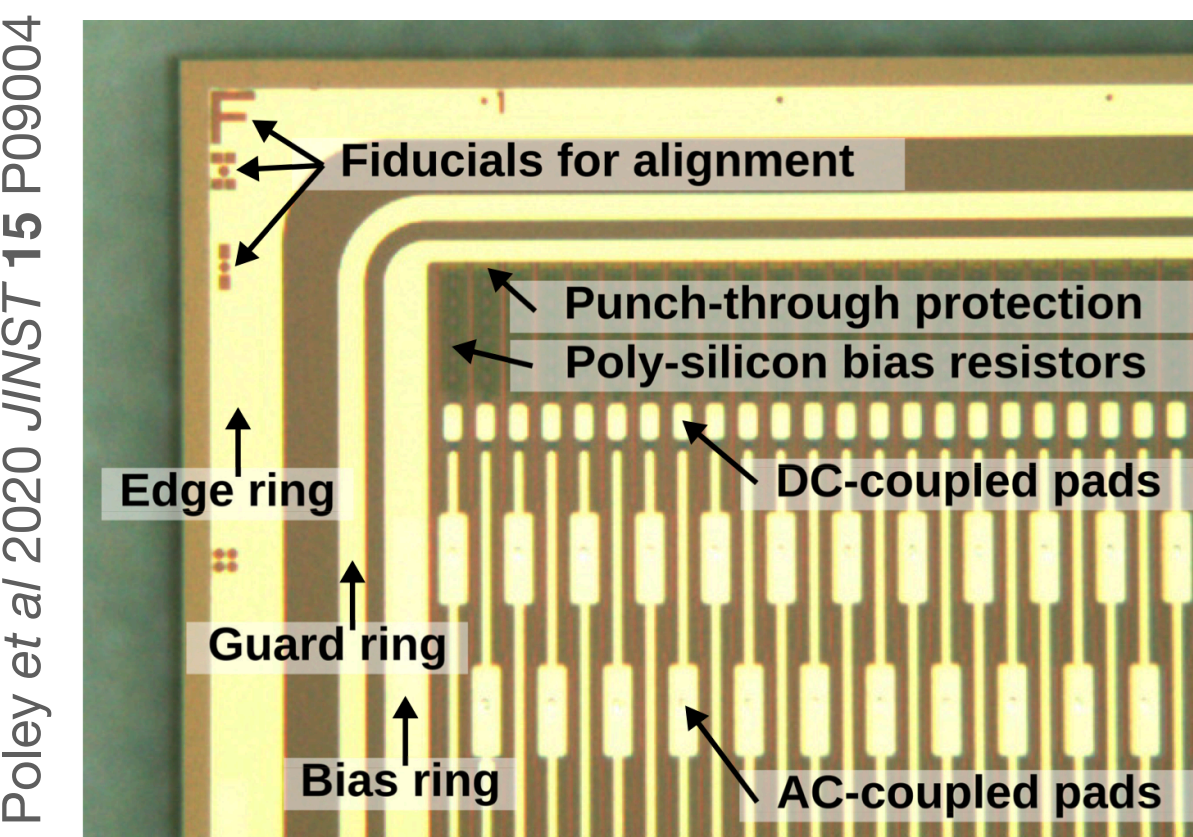
Expected resolution for single muons with 100-GeV transverse momentum

Inner Detector (ID)		Inner Tracker (ITk)
Detector layers	Si (pixels, strips) & gas trackers	Si trackers (pixels, strips)
Coverage, $ \eta $	<2.5 (Pixel & SCT), <2.0 (TRT)	<4.0 (pixels), <2.7 (strips)
Trigger rate	100 kHz	1 MHz
Pixel detector		ITk Pixels
N ^o of Pixels	92 million (80M Pixel + 12M IBL)	5 billion
Pixel silicon area	1.9 m ²	12.98 m ²
Pixel size	50x250 μm (IBL), 50x400 μm , 50x600 μm	50x50 μm , 25x100 μm
SCT		ITk Strips
N ^o of Strips	6.2 M	59.9 M
Strip silicon area	61 m ²	165 m ²
Pitch	80 μm	75.5 μm
Strip length	12.8 cm	1.4-6.0 cm

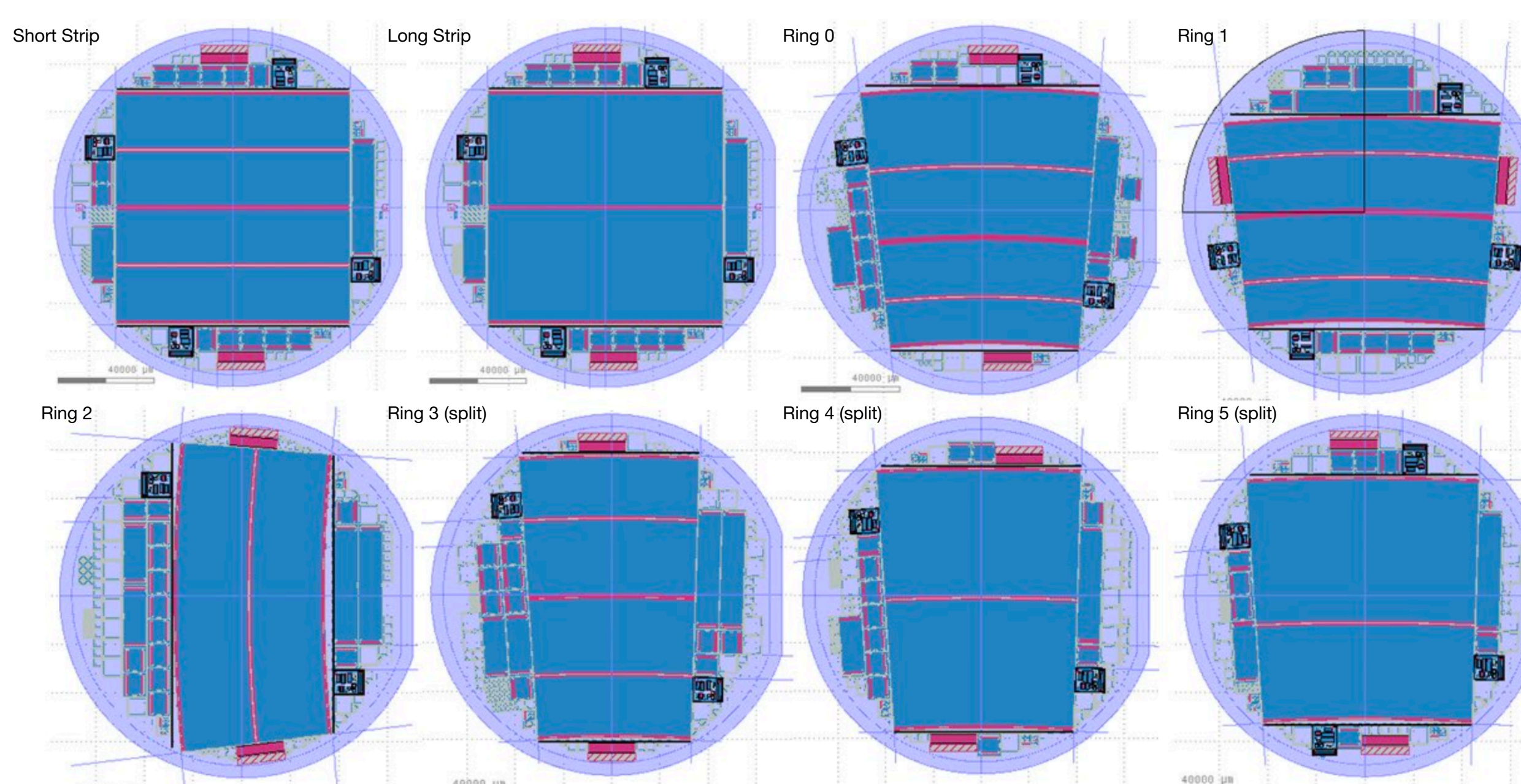
Comparison of ATLAS' current Inner Detector and the future ITk for HL-LHC

Strip components

SENSORS
FZ n⁺ strips implanted on p-type Si bulk (n⁺-in-p) • 300- μm thick



Detail image: Barrel module sensor

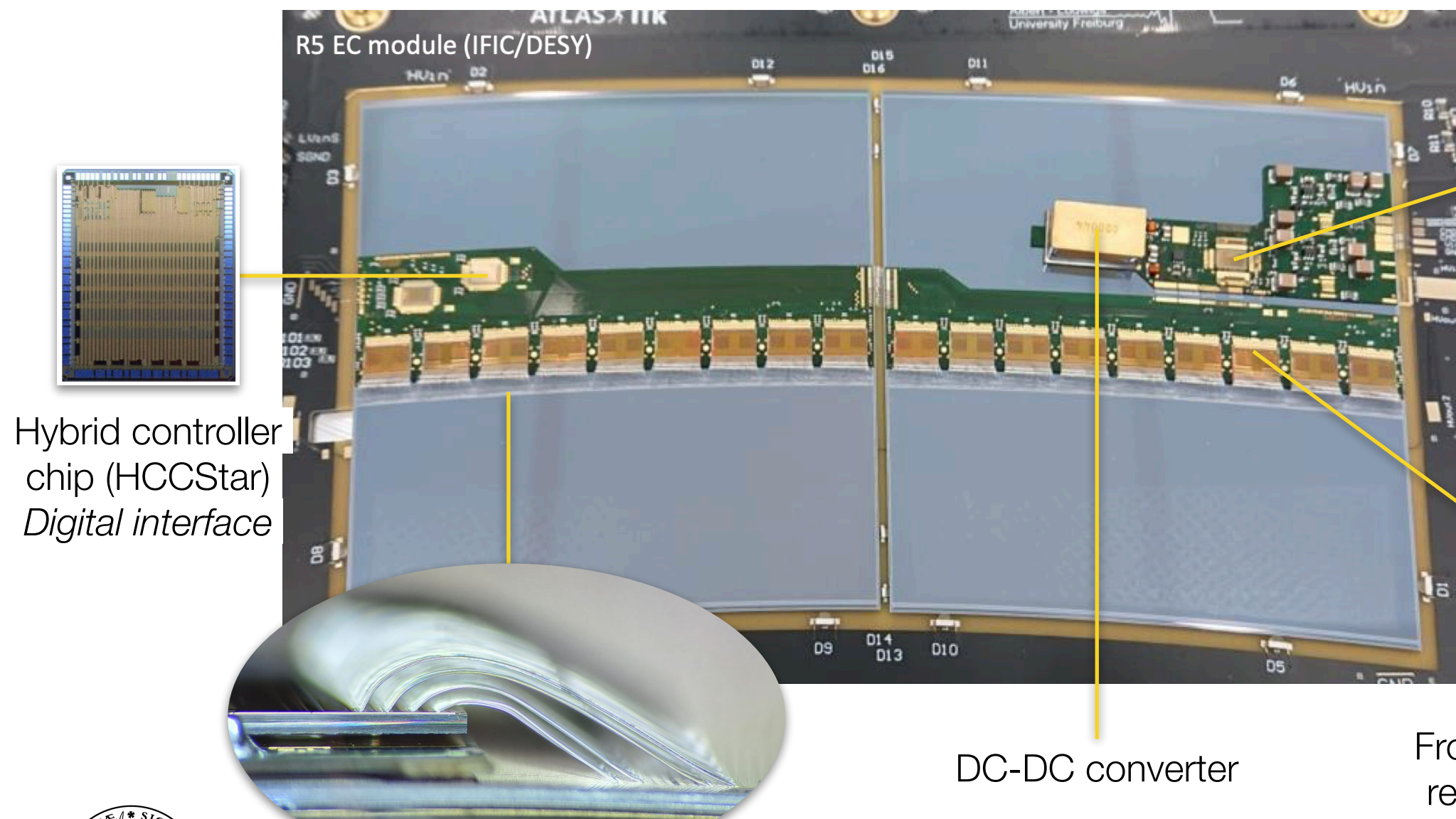


Sensors manufactured in 6-cm wafer technology. Split modules (Ring 3-5) are too large for a single wafer.

Strip components

MODULES Fundamental detector units

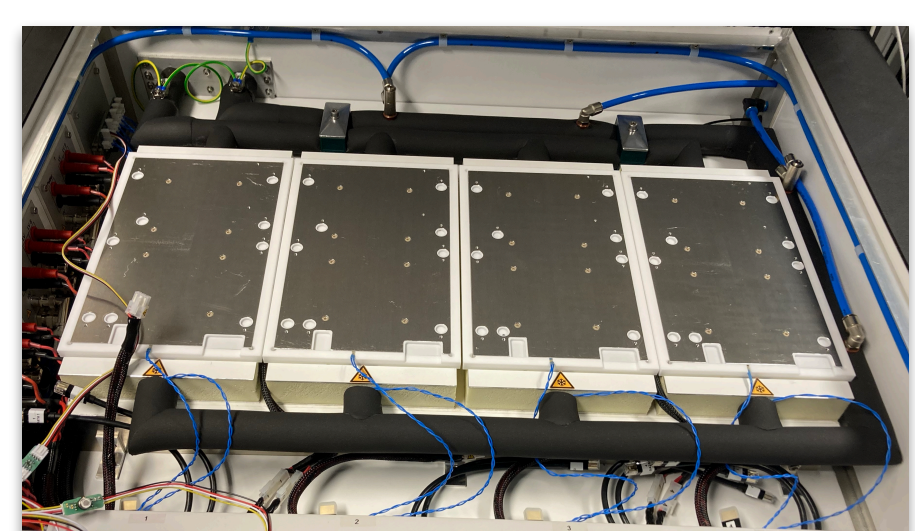
Autonomous monitoring & Control chip (AMAC)



Hybrid controller chip (HCCStar)
Digital interface

DC-DC converter

Front-end: ATLAS binary readout chip (ABCStar)



Climate-controlled thermal cycling chamber for 4 modules

Towards integration

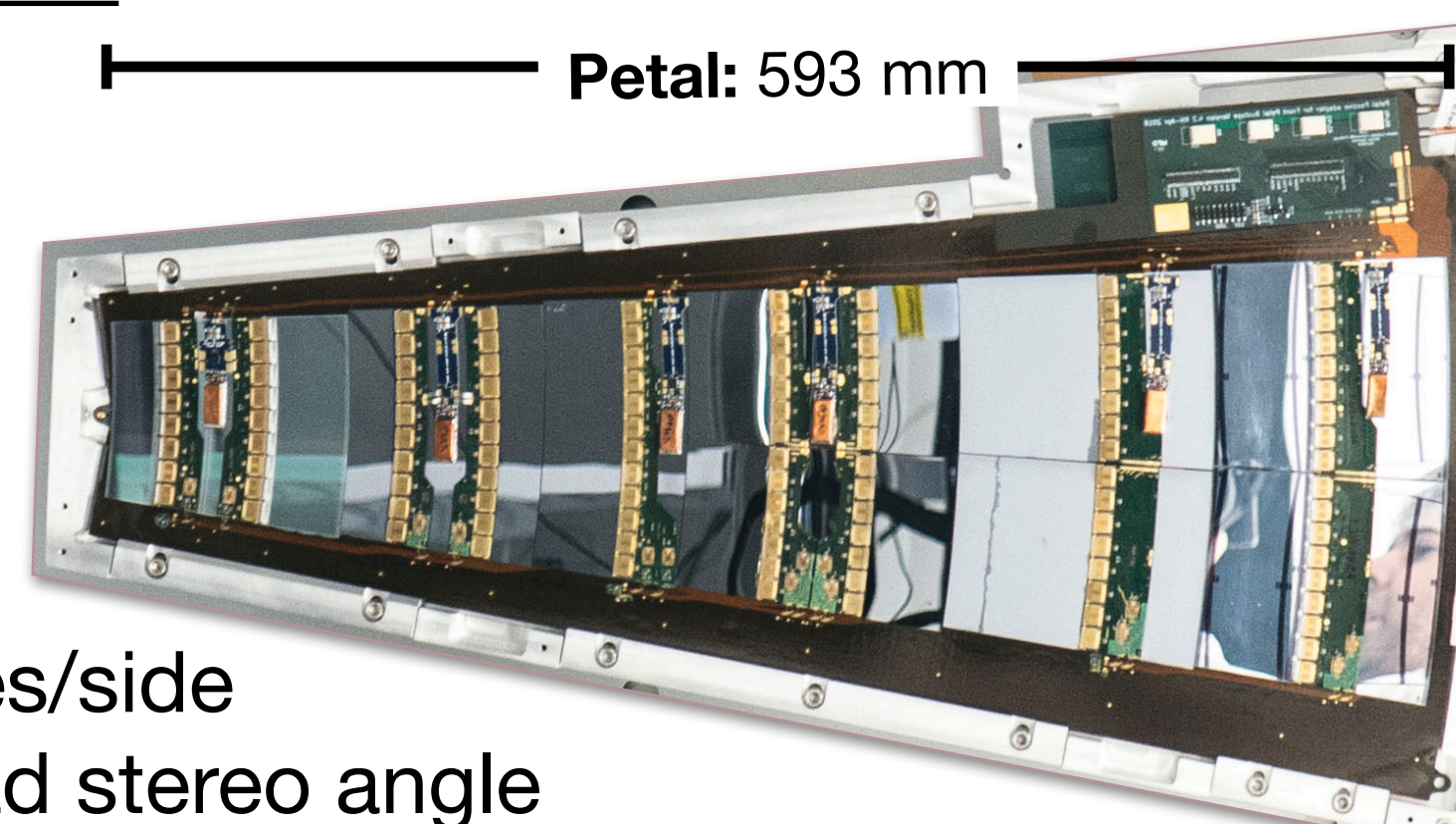
LOCAL SUPPORTS

Mechanical support, cooling, electrical lines

Barrel: Stave, 14 modules/side, 52-mrad stereo angle

Endcap: Petal, 6 modules/side

(3 split modules), 40-mrad stereo angle



Stave: 1400 mm



References
ATLAS Detector: 2008 JINST 3 S08003 • IBL Technical Design Report (TDR): CERN-LHCC-2010-013
ITk Pixels TDR: CERN-LHCC-2017-021 • ITk Strips TDR: CERN-LHCC-2017-005
Layout and expected performance: ATL-PHYS-PUB-2021-024 • L. Poley et al 2020 JINST 15 P09004



